

具有 I²C 接口的 128 抽头单通道数字电位器

查询样品: [TPL0401A](#), [TPL0401B](#), [TPL0401C](#)

特性

- 单通道、128 位分辨率
- 10kΩ 端到端电阻选项
- 低温度系数: 35ppm/°C
- I²C 串行接口
- 2.7V 至 5.5V 单电源运行
- ±20% 电阻容差
- 'A' 和 'B' 版本具有不同的 I²C 地址
- 'A' 和 'B' 版本的 'L' 端子是内部的且被连接至接地 (GND)
- 'C' 版本的 'H' 端子是内部的且悬空
- 运行温度为 -40°C 至 125°C
- 采用行业标准 SC70 封装
- 根据 JESD 22 测试得出的静电放电 (ESD) 性能
 - 2000 V 人体模式 (A114B, II 类)

应用范围

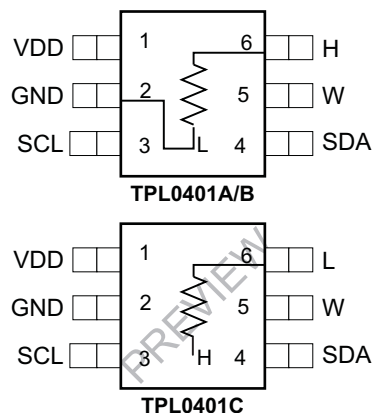
- 低功率 DDR3 电压基准
- 可调电源
- 可调增益放大器和偏移修剪
- 设定点阈值的精度校准
- 传感器微调和校准
- 机械电位器的替代产品

说明

TPL0401 是一款单通道线性锥形数字电位器, 带有 128 个抽头位置。TPL0401A/B 有内部且被连接至 GND 的低端子。可使用 I²C 接口来调节抽头位置。TPL0401 采用 6 引脚 SC-70 封装, 具有 -40°C 至 125°C 额定温度范围。该器件具有 10kΩ 端到端电阻并可在 2.7V 至 5.5V 的电源电压范围工作。此类产品被广泛用于为低功率 DDR3 内存设置电压基准。

TPL0401A/B 有内部并且被连接至 GND 的低端子。
TPL0401C 有内部并且悬空的高端子。

SC-70 DCK 封装
(顶视图)



订购信息

T _A	封装 ⁽¹⁾		可订购部件号	端到端电阻	I ² C 地址	正面标记
-40°C 至 125°C	SC70--DCK	卷带封装	TPL0401A-10DCKR	10kΩ	0101110	7TV
			TPL0401B-10DCKR	10kΩ	0111110	7UV
			TPL0401C-50DCKR	50kΩ	0101110	待定 (TBD)

(1) 封装图示, 标准包装数量, 散热数据, 符号以及 PCB 设计指南可从以下网址获得: www.ti.com/sc/package.



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English Data Sheet: [SLIS144](#)

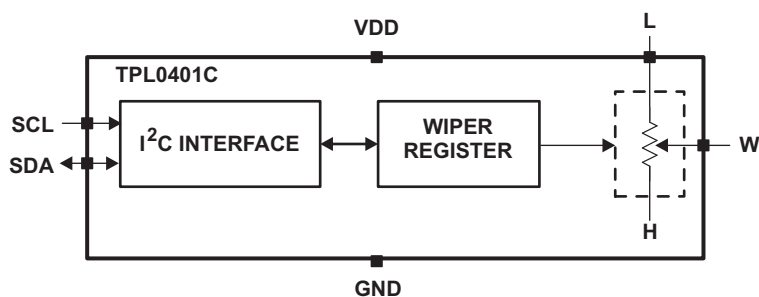
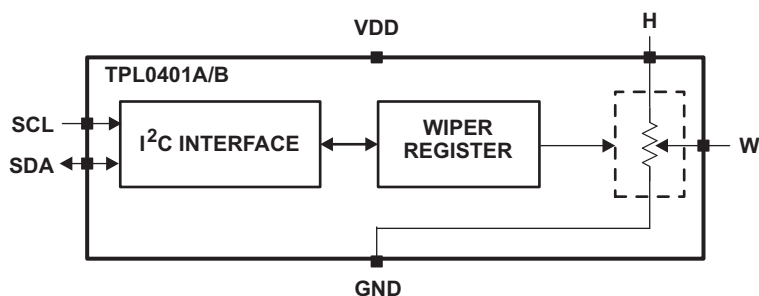


These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

PIN FUNCTIONS

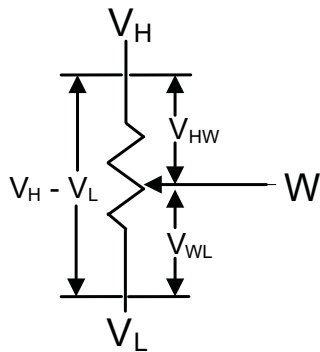
PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
1	VDD	Power	Positive Supply Voltage
2	GND	Ground	Ground
3	SCL	Input	I2C Clock
4	SDA	I/O	I2C Data
5	W	I/O	Wiper terminal
6	H	I/O	High terminal
–	L	I/O	Low terminal

FUNCTIONAL BLOCK DIAGRAM



DIGITAL POTENTIOMETER CONFIGURATIONS

VOLTAGE DIVIDER MODE

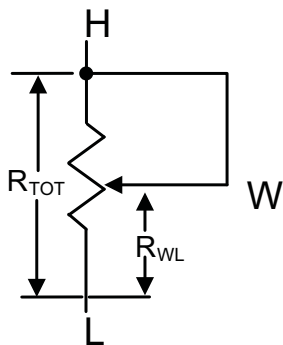


$$V_{HW} = (V_H - V_L) \times (1 - (D/128))$$

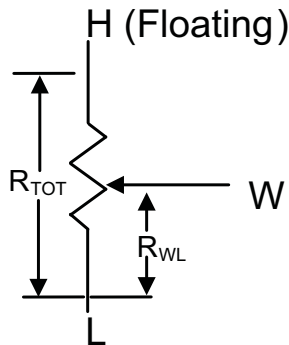
$$V_{WL} = (V_H - V_L) \times D/128$$

Where D = Decimal Value of Wiper Code

RHEOSTAT MODE A



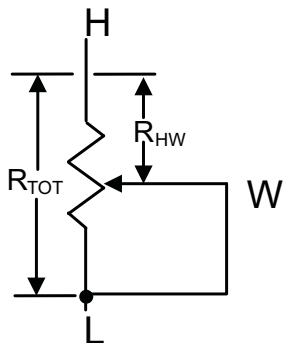
OR



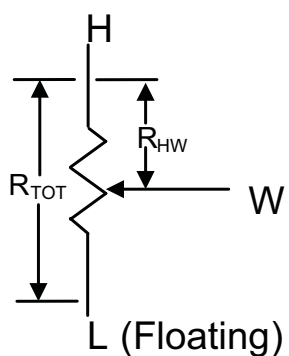
$$R_{WL} = R_{TOT} \times D/128$$

Where D = Decimal Value of Wiper Code

RHEOSTAT MODE B



OR



$$R_{HW} = R_{TOT} \times (1 - (D/128))$$

Where D = Decimal Value of Wiper Code

Figure 1. DPOT Configurations

ABSOLUTE MAXIMUM RATINGS⁽¹⁾⁽²⁾⁽³⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{DD} to GND	Supply voltage range	–0.3	7	V
All other pins to GND		–0.3	V _{DD} +0.3	V
I _H	Pulse current		±20	mA
I _L	Continuous current		±5	mA
I _W			±1.3	mA
V _I	Digital input voltage range	–0.3	V _{DD} + 0.3	V
θ _{JA}	Package thermal impedance ⁽⁴⁾		259	°C/W
T _{stg}	Storage temperature range	–65	150	°C

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
- (3) All voltages are with respect to ground, unless otherwise specified.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS

	DESCRIPTION	MIN	MAX	Unit
V _{DD}	Supply Voltage	2.7	5.5	V
V _W , V _H	Terminal Voltage	0	V _{DD}	V
V _{IH}	Voltage Input High (SCLK, SDA)	0.7 V _{DD}		V
V _{IL}	Voltage Input Low (SCLK, SDA)		0.3 V _{DD}	V
I _W	Wiper Current		±2	mA
T _A	Ambient Operating temperature	–40	128	°C

ANALOG SPECIFICATIONS

Typical values are specified at 25°C and V_{DD}=3.3V

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNIT
R _{TOTAL}	End-to-end resistance (between H and L terminals)	TPL0401A/B-10	8	10	12	kΩ
		TPL0401C-50	40	50	60	kΩ
V _H	Terminal voltage range		0	VDD		V
R _H	Terminal resistance		35		100	Ω
R _W	Wiper resistance		35		100	Ω
C _H	Terminal capacitance		10			pF
C _W	Wiper capacitance		11			pF
I _{LKG}	Terminal leakage current		0.1		1	μA
TC _R	Resistance temperature coefficient	TPL0401A/B-10	22			ppm/°C
		TPL0401C-50	TBD			ppm/°C
VOLTAGE DIVIDER MODE (TPL0401A, TPL0401B, V _H = V _{DD} , V _W = Not Loaded)						
INL	Integral non-linearity		−0.5		0.5	LSB
DNL	Differential non-linearity		−0.25		0.25	LSB
ZS _{ERROR}	Zero-scale error		0	0.75	1.5	LSB
FS _{ERROR}	Full-scale error		−1.5	−0.75	0	LSB
T _{CV}	Ratiometric temperature coefficient	Wiper set at mid-scale	4			ppm/°C
BW	Bandwidth	Wiper set at mid-scale, C _{LOAD} = 10 pF	2862			kHz
T _{SW}	Wiper settling time		0.152			μS
THD	Total harmonic distortion	V _H = 1 V _{RMS} at 1 kHz, V _L = V _{DD} /2, Measurement at W			0.03	%
RHEOSTAT MODE (TPL0401C)						
RINL	Integral non-linearity				TBD	LSB
RDNL	Differential non-linearity				TBD	LSB
R _{OFFSET}	Offset				TBD	LSB
RBW	Bandwidth	Code=0x00h, L Floating, Input applied to W, 10pF on H			TBD	kHz

OPERATING SPECIFICATIONS

Typical values are specified at 25°C and V_{DD}=3.3V⁽¹⁾

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNIT
I _{DD} (STBY)	V _{DD} Standby current	-40 to 85°C			0.5	μA
		-40 to 125°C			1.5	μA
I _{IN-DIG}	Digital Pins Leakage Current (SCL, SDA Inputs)		-1		1	μA
SERIAL INTERFACE SPECS (SDA, SCL)						
V _{IH}	Input high voltage		0.7 × V _{DD}		5.5	V
V _{IL}	Input low voltage		0		0.3 × V _{DD}	V
V _{OL}	Output low voltage	SDA Pin, I _{OL} = 4 mA			0.4	V
C _{IN}	Pin capacitance	SCL, SDA Inputs		7		pF
I²C INTERFACE TIMING REQUIREMENTS						
		STANDARD MODE I ² C BUS		FAST MODE I ² C BUS		UNITS
		MIN	MAX	MIN	MAX	
f _{SCL}	I ² C Clock frequency	0	100	0	400	kHz
t _{SCH}	I ² C Clock high time	4		0.6		μs
t _{SCL}	I ² C Clock low time	4.7		1.3		μs
t _{sp}	I ² C Spike time	0	50	0	50	ns
t _{SDS}	I ² C Serial data setup time	250		100		ns
t _{SDH}	I ² C Serial data hold time	0		0		ns
t _{ICR}	I ² C Input rise time		1000	20 + 0.1C _b	300	ns
t _{ICF}	I ² C Input fall time		300	20 + 0.1C _b	300	ns
t _{ICF}	I ² C Output fall time, 10 pF to 400 pF bus		300	20 + 0.1C _b	300	ns
t _{BUF}	I ² C Bus free time between stop and start	4.7		1.3		μs
t _{STS}	I ² C Start or repeater start condition setup time	4.7		1.3		μs
t _{STH}	I ² C Start or repeater start condition hold time	4		0.6		μs
t _{SPS}	I ² C Stop condition setup time	4		0.6		μs
t _{VD(DATA)}	Valid data time, SCL low to SDA output valid		1		1	μs
t _{VD(DATA)}	Valid data time of ACK condition, ACK signal from SCL low to SDA (out) low		1		1	μs

(1) Parameters with Min and Max limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested

TYPICAL CHARACTERISTICS

**INL vs
TAP POSITION (Potentiometer Mode)**

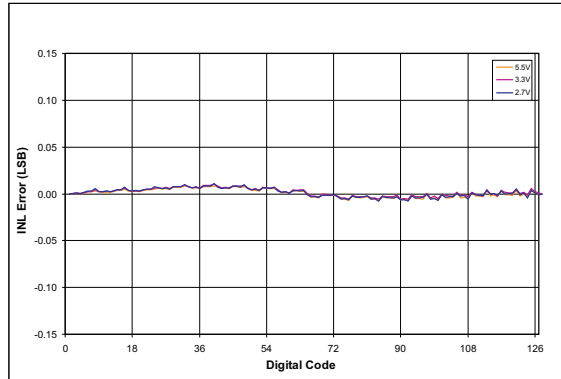


Figure 2.

**DNL vs
TAP POSITION (Potentiometer Mode)**

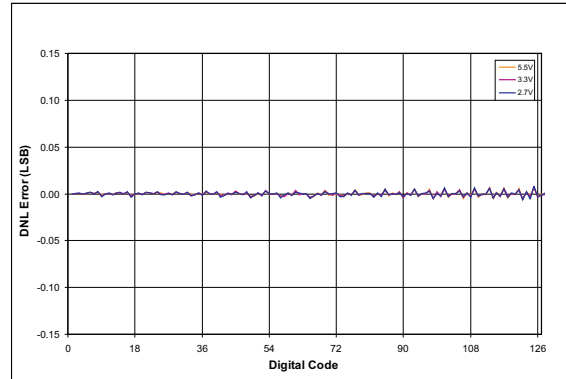


Figure 3.

**INL vs
TAP POSITION (Rheostat Mode)**

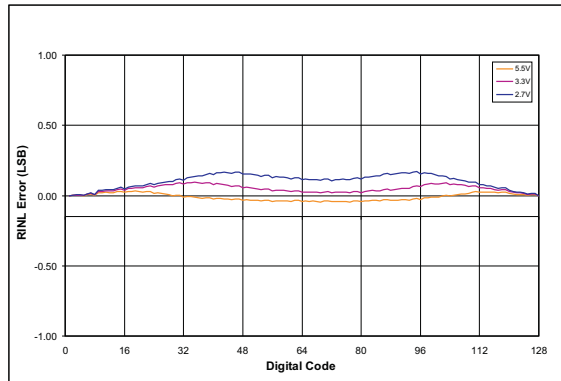


Figure 4.

**DNL vs
TAP POSITION (Rheostat Mode)**

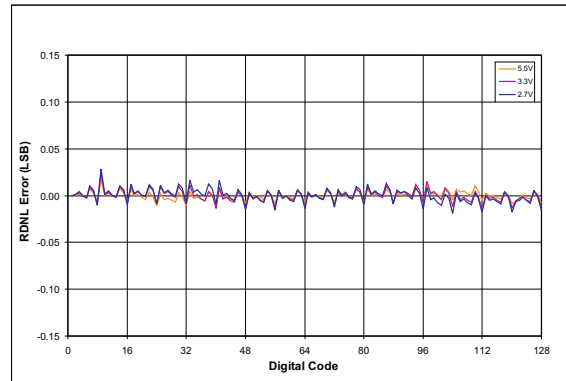


Figure 5.

**ZERO SCALE ERROR vs
TEMPERATURE**

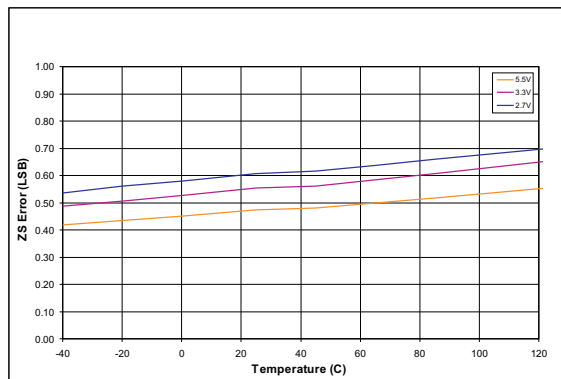


Figure 6.

**FULL SCALE ERROR vs
TEMPERATURE**

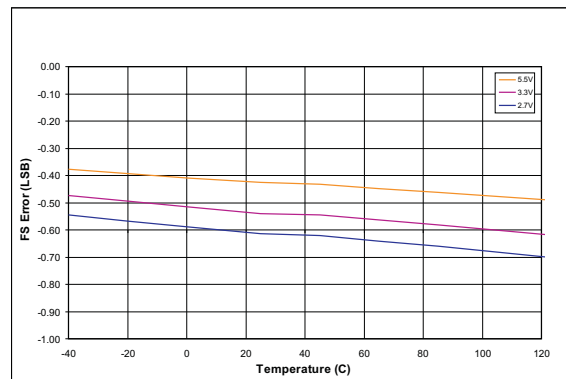


Figure 7.

TYPICAL CHARACTERISTICS (continued)

END-TO-END RTOTAL% CHANGE vs
TEMPERATURE

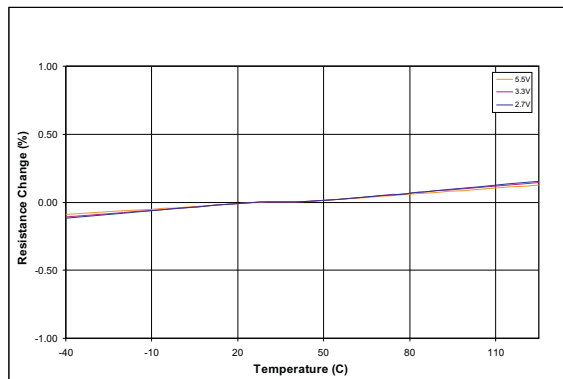


Figure 8.

TEMPERATURE COEFFICIENT vs
TAP POSITION (Potentiometer Mode)

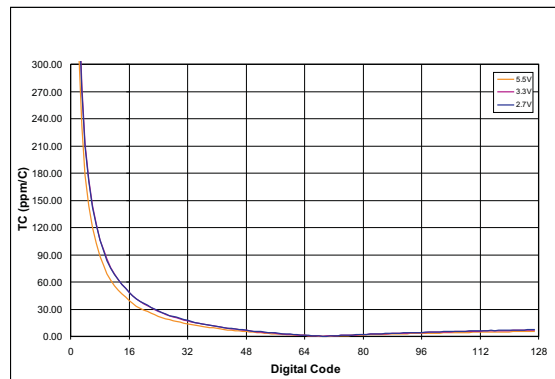


Figure 9.

TEMPERATURE COEFFICIENT vs
TAP POSITION (Rheostat Mode)

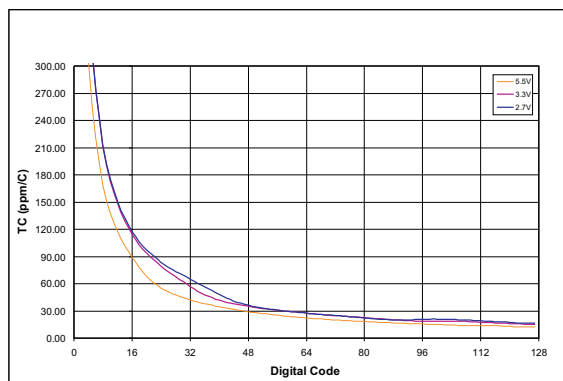


Figure 10.

FREQUENCY RESPONSE

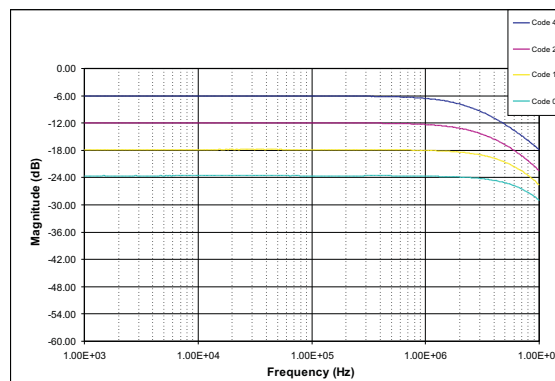


Figure 11.

SLAVE ADDRESS

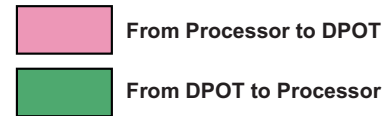
TPL0401A, TPL0401C

BIT 7 (MSB)	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0 (LSB)
0	1	0	1	1	1	0	R/W

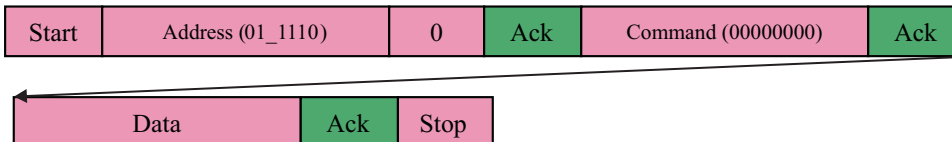
TPL0401B

BIT 7 (MSB)	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0 (LSB)
0	1	1	1	1	1	0	R/W

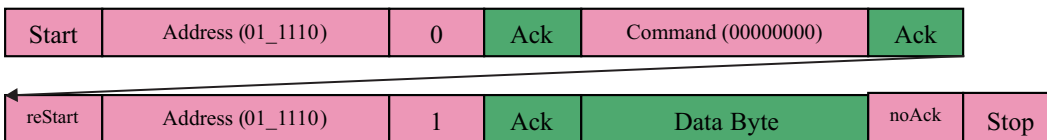
WRITE AND READ PROTOCOL



I²C Write to A Register



I²C Read From A Register



Standard I²C Interface Details

The bidirectional I²C bus consists of the serial clock (SCL) and serial data (SDA) lines. Both lines must be connected to a positive supply via a pullup resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

I²C communication with this device is initiated by the master sending a start condition, a high-to-low transition on the SDA input/output while the SCL input is high (see Figure 13). After the start condition, the device address byte is sent, MSB first, including the data direction bit (R/W). This device does not respond to the general call address. After receiving the valid address byte, this device responds with an ACK, a low on the SDA input/output during the high of the ACK-related clock pulse.

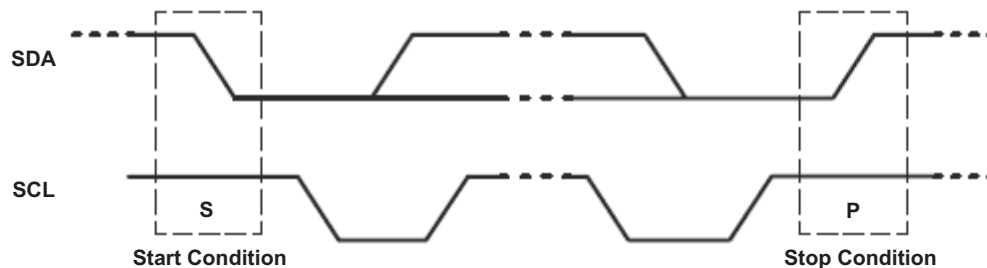


Figure 12. Definition of Start and Stop Conditions

The data byte follows the address ACK. The R/W bit is kept low for transfer from the master to the slave. The data byte is followed by an ACK sent from this device. Data are output only if complete bytes are received and acknowledged. The output data is valid at time (tpv) after the low-to-high transition of SCL, during the clock cycle for the ACK.

On the I²C bus, only one data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the high pulse of the clock period, as changes in the data line at this time are interpreted as control commands (start or stop) (see Figure 13).

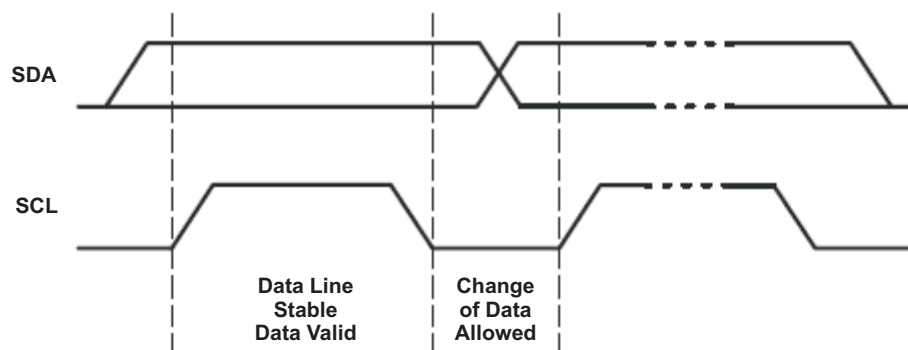


Figure 13. Bit Transfer

A stop condition, a low-to-high transition on the SDA input/output while the SCL input is high, is sent by the master (see Figure 13).

The number of data bytes transferred between the start and the stop conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one ACK bit. The transmitter must release the SDA line before the receiver can send an ACK bit.

A slave receiver that is addressed must generate an ACK after the reception of each byte. The device that acknowledges has to pull down the SDA line during the ACK clock pulse so that the SDA line is stable low during the high pulse of the ACK-related clock period (see Figure 14). Setup and hold times must be taken into account.

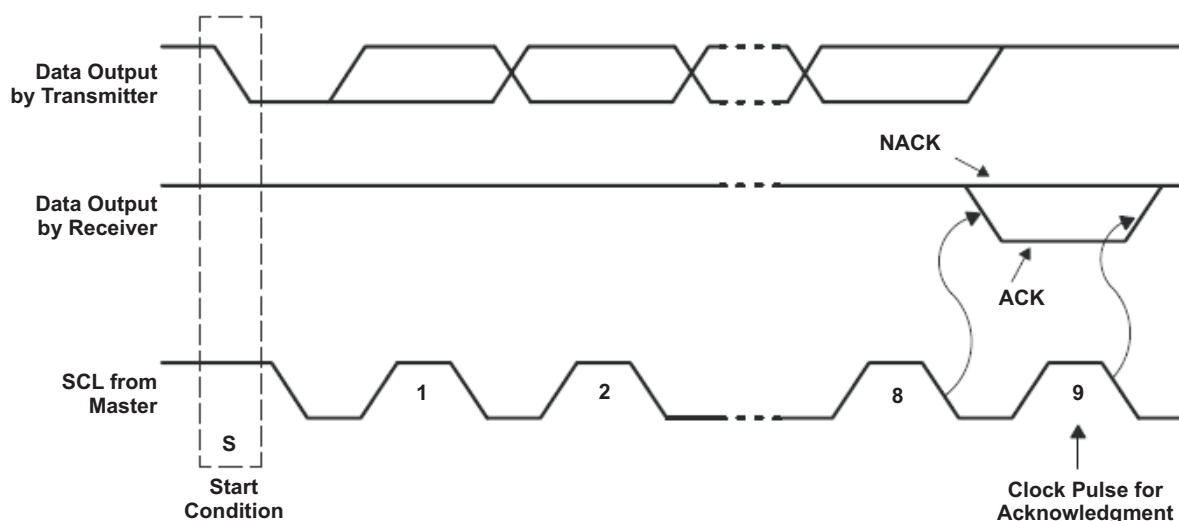


Figure 14. Acknowledgement on the I²C Bus

TYPICAL APPLICATION

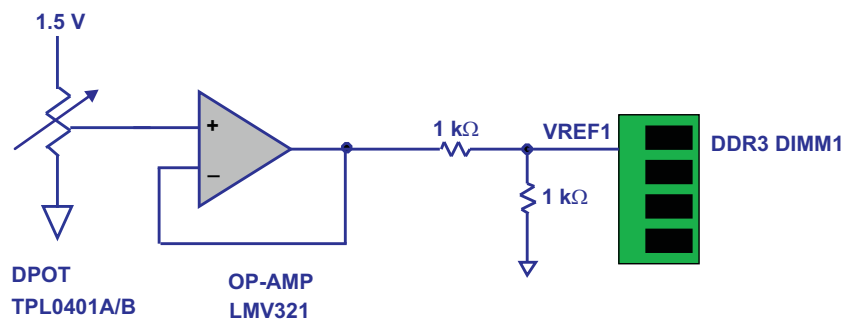


Figure 15. DDR3 Voltage Reference Adjustment

Below table shows Ideal values of resistance for a 10kΩ DPOT. The absolute values can vary significantly, but the ratio (R_{hw}/R_{wl}) is extremely accurate.

Table 1. Resistance Values Table

Step	Binary	R _{wl} (kΩ)	R _{hw} (kΩ)	R _{hw} /R _{wl}
0	0	0.00	10.00	0.00
1	1	0.08	9.92	0.01
2	10	0.16	9.84	0.02
3	11	0.23	9.77	0.02
4	100	0.31	9.69	0.03
5	101	0.39	9.61	0.04
6	110	0.47	9.53	0.05
7	111	0.55	9.45	0.06
8	1000	0.63	9.38	0.07
9	1001	0.70	9.30	0.08
10	1010	0.78	9.22	0.08
11	1011	0.86	9.14	0.09
12	1100	0.94	9.06	0.10
13	1101	1.02	8.98	0.11
14	1110	1.09	8.91	0.12
15	1111	1.17	8.83	0.13
16	10000	1.25	8.75	0.14
17	10001	1.33	8.67	0.15
18	10010	1.41	8.59	0.16
19	10011	1.48	8.52	0.17
20	10100	1.56	8.44	0.19
21	10101	1.64	8.36	0.20
22	10110	1.72	8.28	0.21
23	10111	1.80	8.20	0.22
24	11000	1.88	8.13	0.23
25	11001	1.95	8.05	0.24
26	11010	2.03	7.97	0.25
27	11011	2.11	7.89	0.27
28	11100	2.19	7.81	0.28
29	11101	2.27	7.73	0.29
30	11110	2.34	7.66	0.31
31	11111	2.42	7.58	0.32

Table 1. Resistance Values Table (continued)

Step	Binary	Rwl (k Ω)	Rhw (k Ω)	Rhw/Rwl
32	100000	2.50	7.50	0.33
33	100001	2.58	7.42	0.35
34	100010	2.66	7.34	0.36
35	100011	2.73	7.27	0.38
36	100100	2.81	7.19	0.39
37	100101	2.89	7.11	0.41
38	100110	2.97	7.03	0.42
39	100111	3.05	6.95	0.44
40	101000	3.13	6.88	0.45
41	101001	3.20	6.80	0.47
42	101010	3.28	6.72	0.49
43	101011	3.36	6.64	0.51
44	101100	3.44	6.56	0.52
45	101101	3.52	6.48	0.54
46	101110	3.59	6.41	0.56
47	101111	3.67	6.33	0.58
48	110000	3.75	6.25	0.60
49	110001	3.83	6.17	0.62
50	110010	3.91	6.09	0.64
51	110011	3.98	6.02	0.66
52	110100	4.06	5.94	0.68
53	110101	4.14	5.86	0.71
54	110110	4.22	5.78	0.73
55	110111	4.30	5.70	0.75
56	111000	4.38	5.63	0.78
57	111001	4.45	5.55	0.80
58	111010	4.53	5.47	0.83
59	111011	4.61	5.39	0.86
60	111100	4.69	5.31	0.88
61	111101	4.77	5.23	0.91
62	111110	4.84	5.16	0.94
63	111111	4.92	5.08	0.97
64	1000000	5.00	5.00	1.00
65	1000001	5.08	4.92	1.03
66	1000010	5.16	4.84	1.06
67	1000011	5.23	4.77	1.10
68	1000100	5.31	4.69	1.13
69	1000101	5.39	4.61	1.17
70	1000110	5.47	4.53	1.21
71	1000111	5.55	4.45	1.25
72	1001000	5.63	4.38	1.29
73	1001001	5.70	4.30	1.33
74	1001010	5.78	4.22	1.37
75	1001011	5.86	4.14	1.42
76	1001100	5.94	4.06	1.46
77	1001101	6.02	3.98	1.51
78	1001110	6.09	3.91	1.56

Table 1. Resistance Values Table (continued)

Step	Binary	Rwl (k Ω)	Rhw (k Ω)	Rhw/Rwl
79	1001111	6.17	3.83	1.61
80	1010000	6.25	3.75	1.67
81	1010001	6.33	3.67	1.72
82	1010010	6.41	3.59	1.78
83	1010011	6.48	3.52	1.84
84	1010100	6.56	3.44	1.91
85	1010101	6.64	3.36	1.98
86	1010110	6.72	3.28	2.05
87	1010111	6.80	3.20	2.12
88	1011000	6.88	3.13	2.20
89	1011001	6.95	3.05	2.28
90	1011010	7.03	2.97	2.37
91	1011011	7.11	2.89	2.46
92	1011100	7.19	2.81	2.56
93	1011101	7.27	2.73	2.66
94	1011110	7.34	2.66	2.76
95	1011111	7.42	2.58	2.88
96	1100000	7.50	2.50	3.00
97	1100001	7.58	2.42	3.13
98	1100010	7.66	2.34	3.27
99	1100011	7.73	2.27	3.41
100	1100100	7.81	2.19	3.57
101	1100101	7.89	2.11	3.74
102	1100110	7.97	2.03	3.92
103	1100111	8.05	1.95	4.12
104	1101000	8.13	1.88	4.33
105	1101001	8.20	1.80	4.57
106	1101010	8.28	1.72	4.82
107	1101011	8.36	1.64	5.10
108	1101100	8.44	1.56	5.40
109	1101101	8.52	1.48	5.74
110	1101110	8.59	1.41	6.11
111	1101111	8.67	1.33	6.53
112	1110000	8.75	1.25	7.00
113	1110001	8.83	1.17	7.53
114	1110010	8.91	1.09	8.14
115	1110011	8.98	1.02	8.85
116	1110100	9.06	0.94	9.67
117	1110101	9.14	0.86	10.64
118	1110110	9.22	0.78	11.80
119	1110111	9.30	0.70	13.22
120	1111000	9.38	0.63	15.00
121	1111001	9.45	0.55	17.29
122	1111010	9.53	0.47	20.33
123	1111011	9.61	0.39	24.60
124	1111100	9.69	0.31	31.00
125	1111101	9.77	0.23	41.67

Table 1. Resistance Values Table (continued)

Step	Binary	Rwl (k Ω)	Rhw (k Ω)	Rhw/Rwl
126	1111110	9.84	0.16	63.00
127	1111111	9.92	0.08	127.00

Changes from Original (September 2011) to Revision A**Page**

• Added TPL0401C 器件到数据表。	1
• Added TPL0401C 封装。	1
• Added TPL0401C Functional Block Diagram.	2

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPL0401A-10DCKR	Active	Production	SC70 (DCK) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(7TD, 7TV)
TPL0401A-10DCKR.B	Active	Production	SC70 (DCK) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(7TD, 7TV)
TPL0401A-10DCKRG4	Active	Production	SC70 (DCK) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	7TV
TPL0401A-10DCKRG4.B	Active	Production	SC70 (DCK) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	7TV
TPL0401B-10DCKR	Active	Production	SC70 (DCK) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(7UD, 7UV)
TPL0401B-10DCKR.B	Active	Production	SC70 (DCK) 6	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(7UD, 7UV)

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF TPL0401A-10, TPL0401B-10 :

- Automotive : [TPL0401A-10-Q1](#), [TPL0401B-10-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION



*All dimensions are nominal

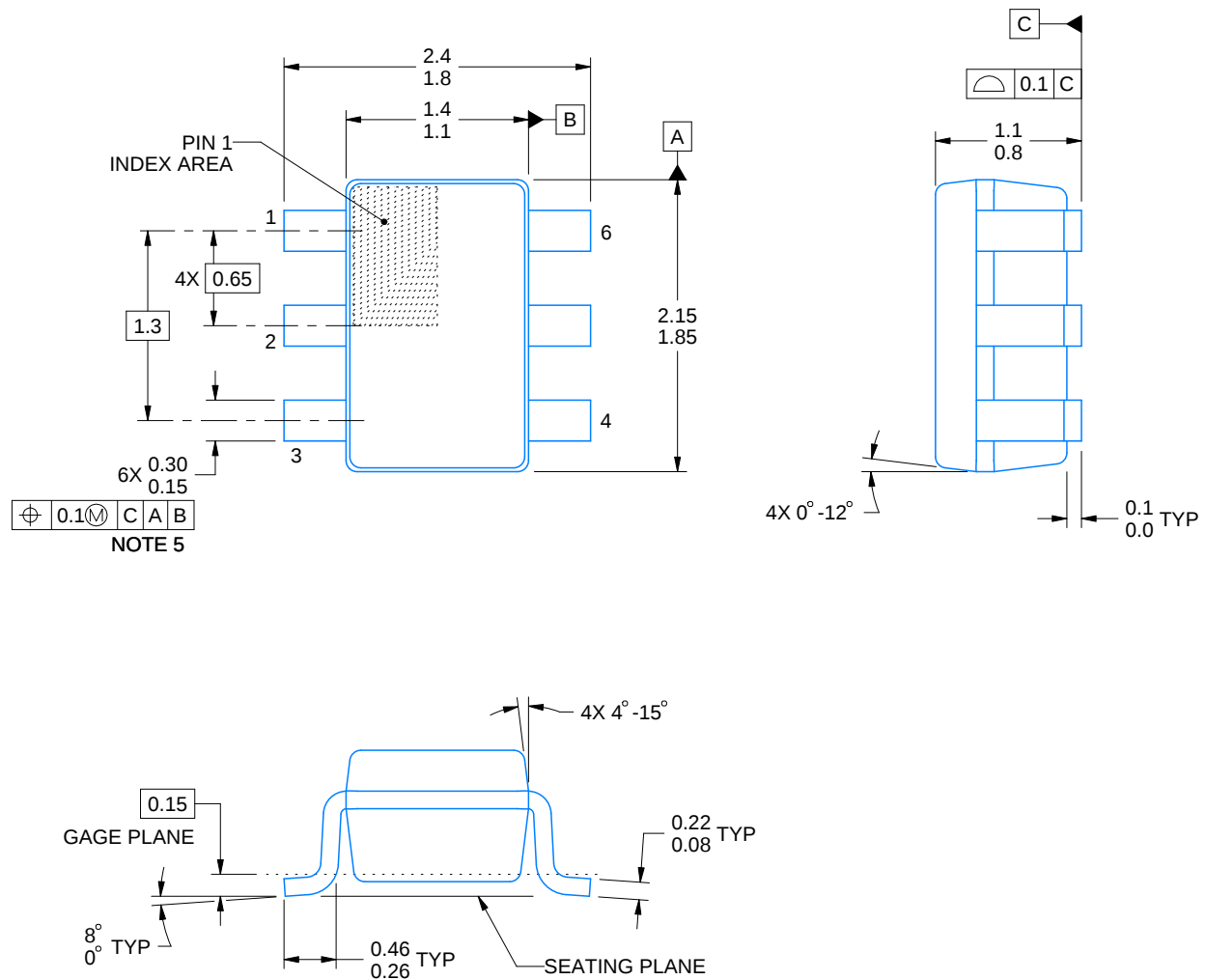
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPL0401A-10DCKR	SC70	DCK	6	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPL0401A-10DCKRG4	SC70	DCK	6	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPL0401B-10DCKR	SC70	DCK	6	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

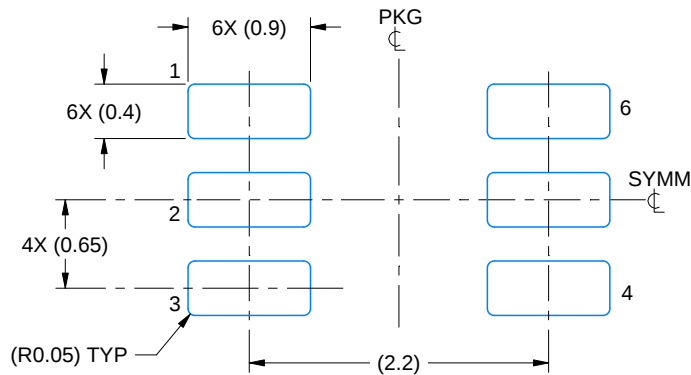
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPL0401A-10DCKR	SC70	DCK	6	3000	202.0	201.0	28.0
TPL0401A-10DCKRG4	SC70	DCK	6	3000	202.0	201.0	28.0
TPL0401B-10DCKR	SC70	DCK	6	3000	202.0	201.0	28.0



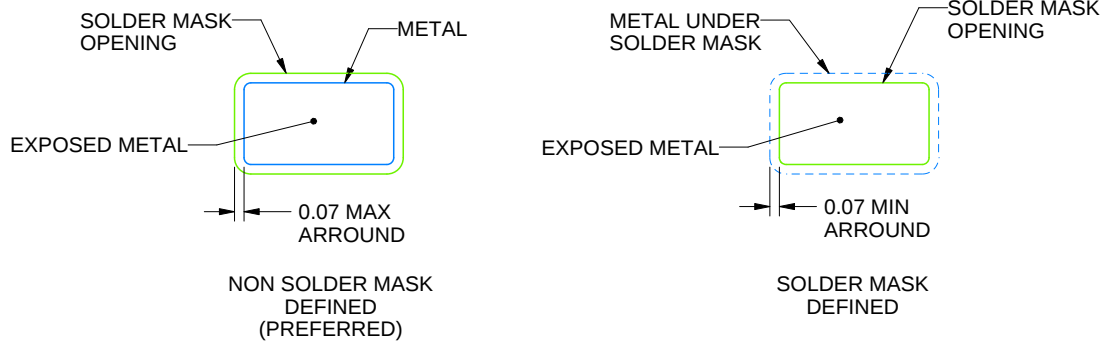
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NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
4. Falls within JEDEC MO-203 variation AB.



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:18X

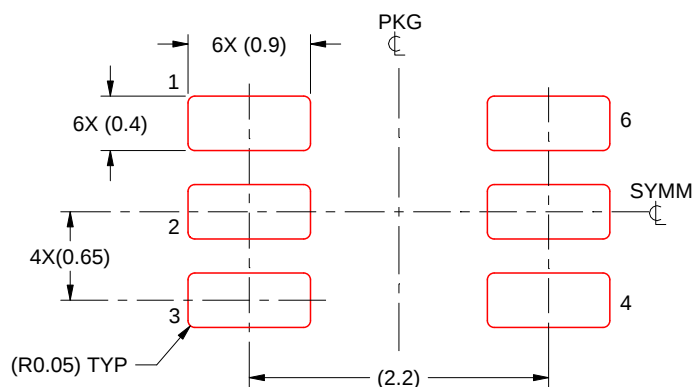


SOLDER MASK DETAILS

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NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:18X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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